smi-6k_20171207.htm

6-K 1 smi-6k_20171207.htm 6-K

UNITED STATES SECURITIES AND EXCHANGE COMMISSION Washington, D.C. 20549

Form 6-K

REPORT OF FOREIGN PRIVATE ISSUER PURSUANT TO RULE 13a-16 OR 15d-16 UNDER THE SECURITIES EXCHANGE ACT OF 1934

For the month of December, 2017

Commission File Number: 001-31994

Semiconductor Manufacturing International Corporation

(Translation of registrant's name into English)

18 Zhangjiang Road
Pudong New Area, Shanghai 201203
People's Republic of China
(Address of principal executive office)

Indicate by check mark whether the registrant files or will file annual reports under cover of Form 20-F or Form 40-F:					
☑ Form 20-F ☐ Form 40-F					
Indicate by check mark if the registrant is submitting the Form 6-K in paper as permitted by Regulation S-T Rule 101(b)(1): □					
Indicate by check mark if the registrant is submitting the Form 6-K in paper as permitted by Regulation S-T Rule 101(b)(7): □					
Indicate by check mark whether the registrant by furnishing the information contained in this Form is also thereby furnishing the information to the Commission pursuant to Rule 12g3-2(b) under the Securities Exchange Act of 1934:					
□ Yes ⊠ No					
If "Yes" is marked, indicate below the file number assigned to the registrant in connection with Rule 12g3-2(b): n/a					

12/13/2017 smi-6k_20171207.htm

1

smi-6k_20171207.htm

SIGNATURES

Pursuant to the requirements of the Securities Exchange Act of 1934, the registrant has duly caused this report to be signed on its behalf by the undersigned, thereunto duly authorized.

Semiconductor Manufacturing International Corporation

Date: December 06, 2017 By: /s/ Dr. Gao Yonggang

Name: Dr. Gao Yonggang

Title: Executive Director, Chief Financial Officer and Joint Company Secretary

2

12/13/2017 smi-6k_20171207.ht

howsoever arising from or in reliance upon the whole or any part of the contents of this announcement.

This announcement is for information purposes only and does not constitute an invitation or solicitation of an offer to acquire, purchase or subscribe for securities of the Company or an invitation to enter into an agreement to do any such things, nor is it calculated to invite any offer to acquire, purchase or subscribe for any securities. This announcement is not an offer of securities for sale in the PRC, Hong Kong and the United States or elsewhere.

announcement, makes no representation as to its accuracy or completeness and expressly asserting any tractitis mississeries for any toos

This announcement does not constitute or form a part of any offer or solicitation to purchase or subscribe for securities in the United States. The Shares mentioned herein have not been, and will not be, registered under the Securities Act, and may not be offered or sold in the United States except pursuant to registration or an exemption from the registration requirements of the Securities Act. No public offering of the Shares will be made in the United States.



SEMICONDUCTOR MANUFACTURING INTERNATIONAL CORPORATION 中 芯 國 際 集 成 電 路 製 造 有 限 公 司 *

(Incorporated in the Cayman Islands with limited liability)
(Stock code: 981)

COMPLETION OF PLACING OF NEW SHARES UNDER GENERAL MANDATE

Sole Global Coordinator J.P. Morgan

Joint Placing Agents

J.P. Morgan Deutsche Bank

Reference is made to the announcement of the Company dated 29 November 2017 (the "Announcement"). Unless otherwise defined, capitalised terms used in this announcement shall have the same meanings as those defined in the Announcement.

COMPLETION OF PLACING OF NEW SHARES UNDER GENERAL MANDATE

The Company is pleased to announce that all the conditions set out in the Placing Agreement have been fulfilled and completion of the Placing Agreement the Company allotted and issued https://www.sec.gov/Archives/edgar/data/1267482/000156459017024648/smi-6k_20171207.htm

Flacing took place on o December 2017. Fursually to the terms and conditions of the Flacing Agreement, the Company another and issued

3

241,418,625 Placing Shares, representing approximately 4.92% of the issued share capital of the Company as enlarged by the issue of the Placing Shares, to not less than six independent Places at the price of HK\$10.65 per Placing Share. The gross proceeds of the Placing are approximately HK\$2.57 billion and the net proceeds of the Placing (after deduction of fees, commissions and expenses) are approximately

HK\$2.55 billion.

To the best of the Directors' knowledge, information and belief, having made all reasonable enquiries, the Placees and their respective ultimate beneficial owners are independent of and not connected with the Company and/or its connected persons.

EFFECT OF THE PLACING ON THE SHAREHOLDING STRUCTURE OF THE COMPANY

The following table illustrates (i) the existing shareholding structure of the Company; and (ii) the shareholding structure of the Company immediately upon completion of the Placing.

	Immediately before completion of the Placing (Note 1)		Immediately upon completion of the Placing (Note 1)	
	•	% of issued		% of issued
		share capital of		share capital of
Shareholder	No. of Shares	the Company	No. of Shares	the Company
Datang	797,996,122	17.08%	797,996,122	16.24%
China IC Fund	740,000,000	15.84%	740,000,000	15.06%
Country Hill				
(Note 2)	90,559,889	1.94%	90,559,889	1.84%
Placees of the Placing Shares	_	V <u>—</u>	241,418,625	4.92%
Other				
Shareholders	3,042,680,015	65.14%	3,042,680,015	61.94%
	4,671,236,026	100%	4,912,654,651	100%

Notes:

1. Assuming that other than the Placing Shares, no further Share is issued or repurchased by the Company, no issue of the Placed PSCS, no issue of the Subscription Securities, no Share option is exercised, no Restricted Share Unit is granted and no conversion into Shares of any securities, immediately before and up to completion of the Placing.

2. Based on the latest information provided to the Company.

None of the Placees has become a substantial shareholder of the Company immediately after the completion of the Placing.

TOTENTIAL EXERCISE OF FRE-EMITTIVE RIGHTS DI DATANG AND CHINA IC FUND

Reference is also made to the Announcement relating to, among other things, the potential exercise of pre-emptive right and the potential further subscription of perpetual subordinated convertible securities by certain shareholders of the Company. Further announcement(s) will be made by the Company upon the entering into of any agreement as a result of such potential exercise of pre-emptive right and further subscription.

By order of the Board
Semiconductor Manufacturing International Corporation
Gao Yonggang
Executive Director, Chief Financial Officer and Joint Company Secretary

Shanghai, 6 December 2017

As at the date of this announcement, the directors of the Company are:

Executive Directors
Zhou Zixue (Chairman)
Zhao HaiJun (Co-Chief Executive Officer)
Liang Mong Song (Co-Chief Executive Officer)
Gao Yonggang (Chief Financial Officer)

Non-executive Directors
Tzu-Yin Chiu (Vice Chairman)
Chen Shanzhi
Zhou Jie
Ren Kai
Lu Jun
Tong Guohua

Independent Non-executive Directors Lip-Bu Tan William Tudor Brown Carmen I-Hua Chang Shang-yi Chiang Jason Jingsheng Cong

* For identification purposes only

12/13/2017 smi-6k_20171207.htm